Deutsche Bank AutoTech Day

Peter Schiefer Division President Automotive

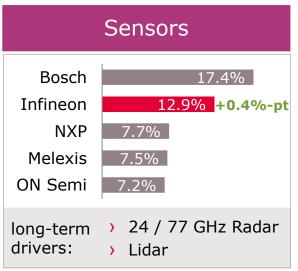
London, 22 June 2018

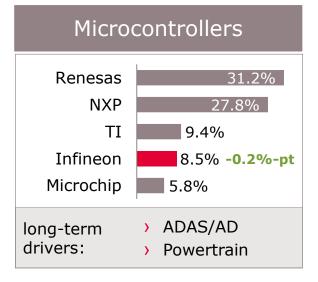


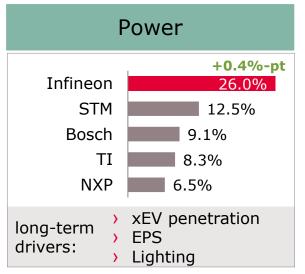
Infineon is well positioned in its addressed automotive product segments











Source: Strategy Analytics, "Automotive Semiconductor Vendor Market Shares", April 2018



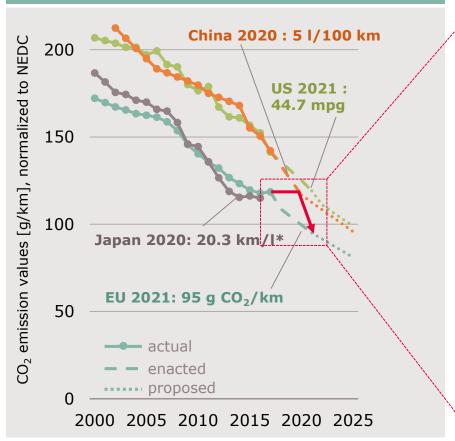
Electro-mobility



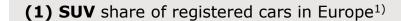
xEV growth driven by emission regulation; but consumer preferences thwart CO₂ reduction



CO₂ emission development and regulations for main regions



Two consumer trends countervail CO₂ reduction





constantly increasing share of heavy ICE SUVs (~150 g CO₂/km) prevents fleet average to come down

(2) **Diesel** share of registered cars in Europe²⁾



Lower positive contribution of Diesel (~15% less CO₂ emissions than gasoline) due to reduced acceptance

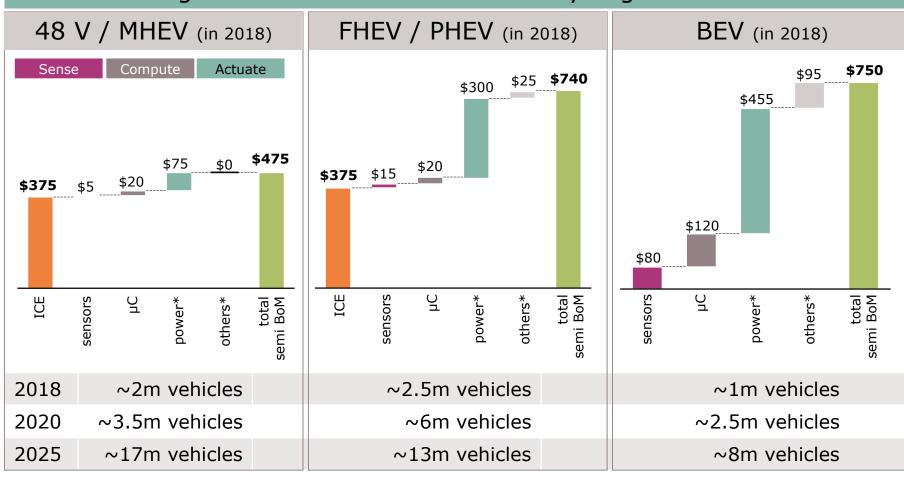
^{*}Note: Japan has already met its 2020 statutory target as of 2013 Source: 1) IHS Markit, Automotive Group, Report, January 2018

²⁾ IHS Markit, Automotive Group, "Light Vehicle Alternative Propulsion Forecast", March 2018

The incremental demand of power semiconductors is a significant opportunity



2018 average xEV semiconductor content by degree of electrification



Source: Strategy Analytics, "Automotive Semiconductor Content", May 2018; Infineon estimates * "power" includes linear and ASIC; "others" include opto, small signal discrete, memory

SiC follows Infineon's standards wrt quality, application understanding, and portfolio size





On-board charger

First design-win to ramp in 2019!



CoolSiC™ Automotive MOSFET



Main inverter

First design-win to ramp in 2020!



HybridPACK[™] Drive CoolSiC[™]
Increased scalability supports OEM platform strategy

- More than 20 leading OEMs and tier-1s are evaluating Infineon's SiC solutions for automotive
- Customer feedback clearly shows that Infineon has deepest understanding of technical quality threats
- Infineon's internal quality test procedures exceed common industry norm; test results proof that Infineon's SiC products reach that quality level
- Industry's broadest portfolio allows customer to "pick what they need" rather than to "take what we have"



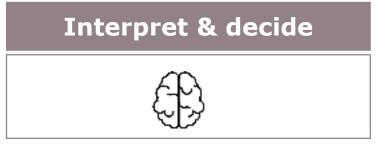
Automated Driving

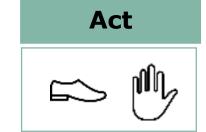


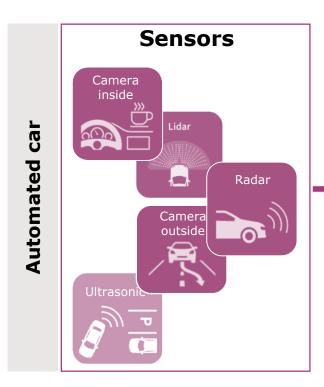
For Automated Driving more compute power but also a higher security and safety is needed

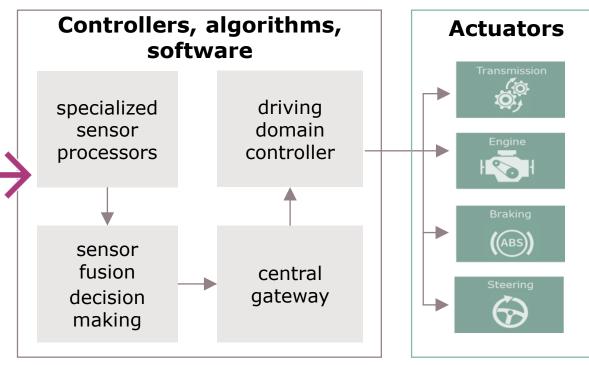












Increased sensor requirements drive the content in the next 5 years and beyond



	More sensors required for any next level of automation					
	NCAP 5 Star, A	D L2	AD L3		AD L4/L5	
Application*	Automatic emergency brake/ forward collision warning					
	Parking assist				Valet parking	
	Lane keep assist	Hig	Highway assist		Highway and urban chauffeur	
Radar # of modules**	Corner MRR/LRR	MRR/LRF	₹		Imaging	
		≥ 3		≥ 6	≥ 10	
	New: Corner start	ing 2020	Corner		Surround	
Camera # of modules**		≥ 1		≥4	≥ 8	
Lidar # of modules**	0			≤ 1	≥ 1	
Others	› Ultrasonic		trasonic Iterior camera	>]	Jltrasonic Interior camera V2X	

^{*} Source: VDA (German Association of the Automotive Industry); Society of Automotive Engineers

^{**} Market assumption

Infineon opens the door for mass-deployable lidar systems for Automated Driving



Classification of long-range lidar systems solid state optical system mechanically moving mirror scanning optical flash lidar scanning MEMS-based mirror phased array proven concept allows optical entire situation robust signal path beam forming captured in realbulky more compact and cost-effective time high demand of expensive roadmap for higher laser power, more complex Infineon \oplus level of integration especially for laser system (more long-range expensive, higher (\blacksquare) more complex to scale field of view power demand) Lidar is Infineon's AD 1st System reference design **MEMS** mirror portfolio expansion adjacent **Infineon** to radar laser diode mirror Infineon intends to repeat AURIX™ driver MEMS mirror its radar success story In addition to MEMS, room detector **FPGA** receiver diodes to increase BoM by receiver, microcontroller, power power supply / power management management ICs

Outstanding characteristics make AURIX™ first-choice µC in the AD platform market



AURIX[™] is the market reference as host controller in central computing platforms complementing CPU/GPU to make central computer robust and fail operational





Go™ Automated Driving Platform with AURIX™









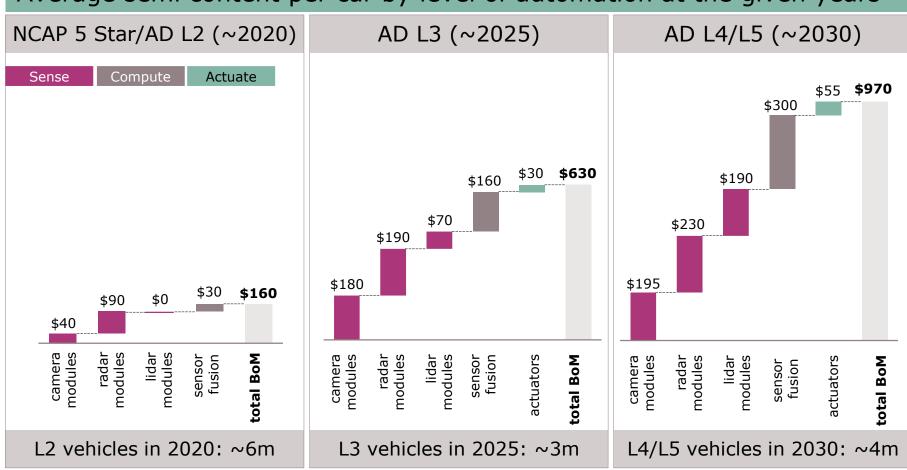


- Safety host monitoring the operation of the data fusion ECU enables ISO 26262 ASIL-D
- Safe and secure gateway to the vehicle network
- Fallback operation in case of a GPU/CPU fail
- Safe communication to actuator control units
- Awareness for safety and security aspects of AD is increasing rapidly
- Infineon is cooperating with the leading AD platform providers

ADAS/AD semi growth driven by radar and camera sensor modules over the next 5 years



Average semi content per car by level of automation at the given years



Source: Strategy Analytics; Infineon

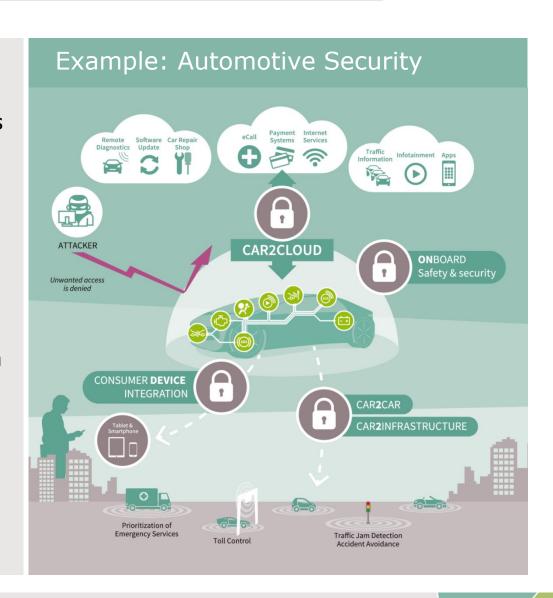
Bill of material (BoM) contains all type of semiconductors (e.g. radar modules include µC); sensor fusion does not include memory

BoM are projected figures for the respective time frame



Security is a system approach

- As humans, machines, 'things' are getting connected, the risks of security attacks increase strongly as attacks paths increase
- Accordingly, there is a greater need for security in fields like smart home, connected cars, information and communication technologies, Industry 4.0
- Many manufacturers of devices and systems do not have the necessary security know-how





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